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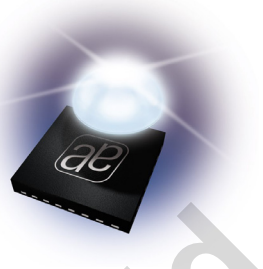
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AS3490

Highly Efficient 2-6 LEDs Backlight Driver with PWM Input



1 General Description

The AS3490 is an inductive highly efficient DCDC boost converter. The DCDC converter operates at a fixed frequency of 2MHz and includes soft startup to allow easy integration into noise sensitive RF systems. A predictable startup is guaranteed even with very low duty cycle PWM input signals. The voltage on the output capacitor is controlled to minimize ripple and to avoid any acoustic effects for low frequency PWM input signals.

The output of the DCDC converter is used for five current sources connected to up to 6 LEDs. If a current source is not required, it shall be connected to VOUT or GND - the AS3490 detects this condition and disables this current source automatically; this keeps the efficiency of the system constantly high.

The AS3490 is controlled by one enable input, ON. This input can also be used to connect a PWM input (like DLS or DBC).

The AS3490 includes several protection functions like undervoltage lockout, overcurrent and overtemperature.

No microvias are required to assemble the AS3490.

The AS3490 is available in a space-saving WL-CSP package measuring only 1.7x1.4x0.5mm and operates over the -30ºC to +85ºC temperature range.

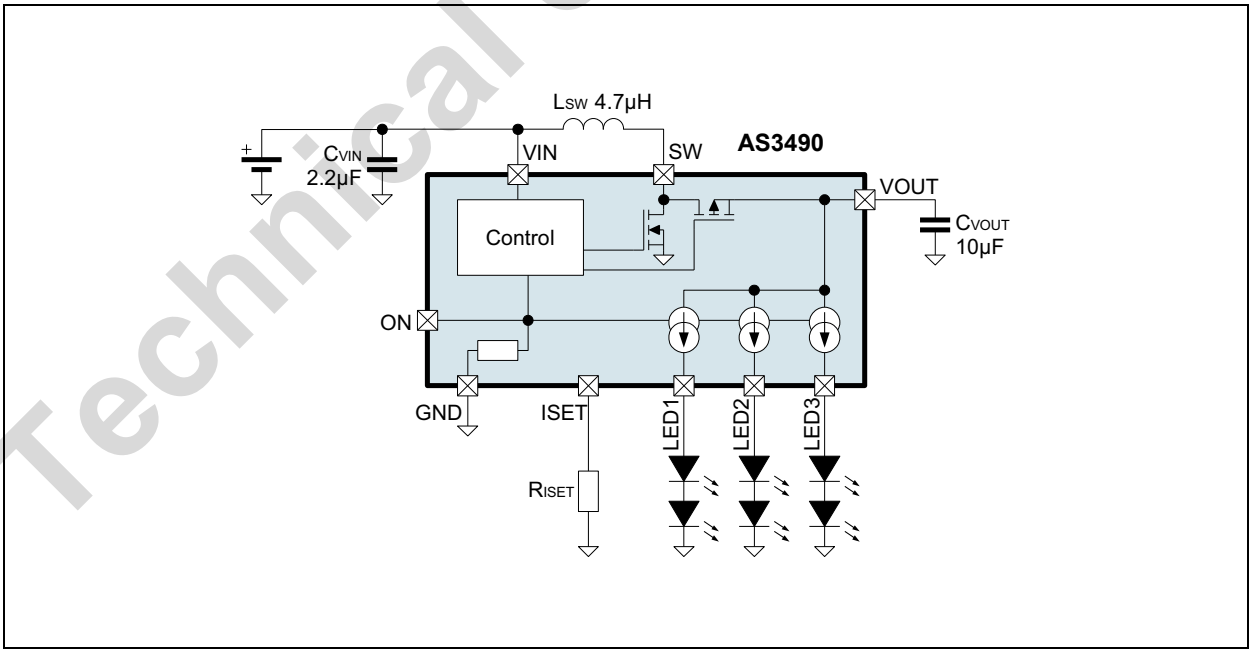
Figure 1. AS3490 Typical Operating Circuit

2 Key Features

- 2 MHz DCDC Boost converter
  - Small 4.7µH external coil
  - Very high system efficiency of 86% (DCDC and current sources combined)
  - Very low voltage changes on output to avoid acoustic noise on output capacitor even with PWM
  - Smooth startup even under low duty cycle PWM conditions
- Three Current sources up to 25mA
  - Low voltage compliance (150mV)
  - High side current source to simplify layout and thermal management of the LEDs
  - Automatically detect and disable failing or not used LEDs to keep efficiency high
  - Current matching <4%
  - Current accuracy <7.5%
- Excellent LED current output ripple <500µA
- Support DLS (Dynamic Luminance Scaling or DBC)
- Undervoltage lockout and overcurrent protection
- Overtemperature protection
- Available in a tiny WL-CSP package
  - 3x4 balls, 0.4mm pitch, 1.7x1.4x0.5mm

3 Applications

Display backlight driver for mobile phones, digital cameras, PND and PMPs.

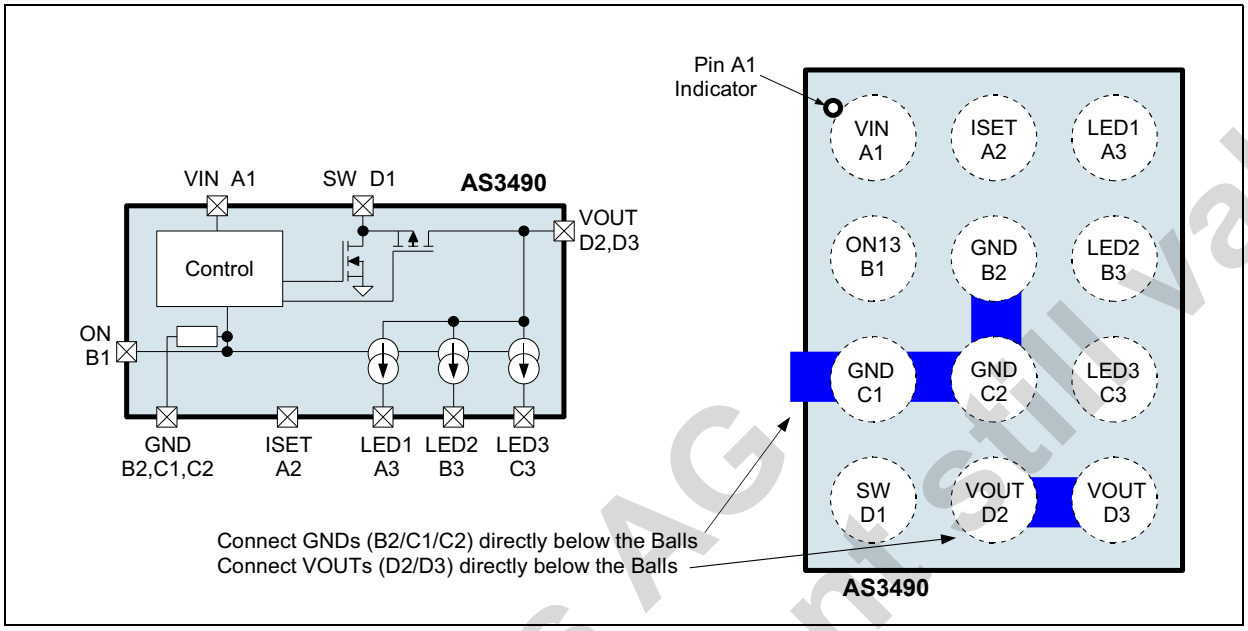


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4 Pinout

Pin Assignment

Figure 2. Pin Assignments (Top View)



Pin Description

Table 1. WL-CSP12 Pin Description

Pin Number	Pin Name	Description
A1	VIN	Positive supply voltage input - connect to supply and make a short connection to input capacitor CVIN
A2	ISET	External current set resistor, forced to 1.25V in operation - LED current typically 400xISET current
A3	LED1	Current source output 1 - controlled by ON
B1	ON	Digital input pin - enable input active high for current sources D1...D3[1]
B2	GND	Supply ground - connect to ground supply
B3	LED2	Current source output 2 - controlled by ON
C1	GND	Supply ground - connect to supply and make a short connection to input capacitor CVIN and CVOUT
C2	GND	Supply ground - connect to ground supply
C3	LED3	Current source output 3 - controlled by ON
D1	SW	DCDC converter switching node
D2	VOUT	DCDC converter output - make a short connection to capacitor COUT
D3	VOUT	Connect directly to Ball D2

1. If ON is low low, the AS3490 enters shutdown.

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5 Absolute Maximum Ratings

Stresses beyond those listed in Table 2 may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in Table 3, “Electrical Characteristics,” on page 4 is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 2. Absolute Maximum Ratings

Parameter	Min	Max	Units	Comments
VIN, ON and ISET to GND	-0.3	+7.0	V	
ON and ISET to VIN		+0.3	V	internal protection diodes to VIN
SW, VOUT, LED1...LED3 to GND	-0.3	11	V	
SW, LED1...LED3 to VOUT		+0.3	V	internal protection diodes to VOUT
Input Pin Current without causing latchup	-100	+100 +I_{IN}	mA	Norm: EIA/JESD78
Continuous Power Dissipation (T_A = +70ºC)				
Continuous power dissipation		870	mW	P_T[1] at T_{AMB}=70ºC
Continuous power dissipation derating factor		11.67	mW/ºC	P_{DERATE}[2]
Electrostatic Discharge				
ESD HBM		±2000	V	Norm: JEDEC JESD22-A114F
ESD CDM		±500	V	Norm: JEDEC JESD 22-C101E
ESD MM		±100	V	Norm: JEDEC JESD 22-A115-B
Temperature Ranges and Storage Conditions				
Junction Temperature		+125	ºC	
Storage Temperature Range	-55	+125	ºC	
Humidity	5	85	%	Non condensing
Body Temperature during Soldering		+260	ºC	according to IPC/JEDEC J-STD-020
Moisture Sensitivity Level (MSL)	MSL 1			Represents a max. floor life time of unlimited

1. Depending on actual PCB layout and PCB used
2. P_{DERATE} derating factor changes the total continuous power dissipation (P_T) if the ambient temperature is not 70ºC. Therefore for e.g. T_{AMB}=85ºC calculate P_T at 85ºC = P_T - P_{DERATE} * (85ºC - 70ºC)

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6 Electrical Characteristics

V_{VIN} = +2.5V to +5.5V, T_{AMB} = -30ºC to +85ºC, unless otherwise specified. Typical values are at V_{VIN} = +3.7V, T_{AMB} = +25ºC, unless otherwise specified.

Table 3. Electrical Characteristics

Symbol	Parameter	Condition		Min	Typ	Max	Unit
General Operating Conditions							
V_{VIN}	Supply Voltage			2.5	3.7	5.5	V
$V_{VIN_REDUCED}$	Supply Voltage reduced performance	not all parameters within specification		2.3			V
$I_{SHUTDOWN}$	Shutdown Current	ON=0V			0.5	2.0	µA
I_{VIN}	Operating Current	no load, PWM Normal mode			250		µA
T_{AMB}	Operating Temperature			-30	25	85	ºC
DCDC Converter parameters							
V_{VOUT}	Output Voltage VOUT	automatically regulated		V_{VIN}+ 0.3V		V_{VOUT_MAX}	V
		all other conditions with ON13=ON45				140	
$V_{VOUT_RIPPLE_PWM}$	Voltage VOUT due to PWM signal	DCDC not in pulseskip or current limit			70		mV
I_{LOAD}	Load current	VOUT<7.5V		0.0		100	mA
η	Overall Efficiency	V_{VIN}=3.7V, T_{AMB} = +25ºC, LED mismatch <= 30mV, V_{LED}=3.0V	I_{LOAD}=50mA		86		%
			I_{LOAD}=75mA	85	86		
			I_{LOAD}=100mA		86		
f_{CLK}	Operating Frequency	All internal timings are derived from this oscillator		-10%	2.0	+10%	MHz
t_{MIN_ON}	Minimum on-time				60		ns
MDC	Maximum Duty Cycle				90		%
R_{SW_P}	DCDC Switch SW - VOUT				0.5		Ω
R_{SW_N}	DCDC Switch SW - GND				0.5		Ω
Output voltage soft start							
t_{VOUT_START}	softstart time	measured from first high signal on ON			1.2		ms
V_{VOUT_START}	VOUT startup voltage				7.0		V
$t_{PWM_START_MAX}$	Startup with PWM	Maximum duration between PWM pulses during startup; see Figure 17 on page 11		10	11	12	ms
$t_{TIMEOUT}$	DCDC timeout time	if ON=0 for $t_{TIMEOUT}$, the DCDC is stopped and the AS3490 enters shutdown		29		48	ms
Current Sources							
$V_{LED1..3}$	LED1...LED3 output voltage range			2.6 x2	3.3 x2	3.9 x2	V
$I_{LED1..3}$	LED1...LED3 output current range			0.0		25.0	mA
$I_{LED1..3\Delta}$	LED1...LED3 current source accuracy [1]	$I_{LED1..3}$ =20mA		-7.5		+7.5	%

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Table 3. Electrical Characteristics (Continued)

Symbol	Parameter	Condition		Min	Typ	Max	Unit
$I_{LED1..3\ MATCH}$	LED1...LED3 current source matching	$I_{LED1..3}$ = 20mA		-4.0		+4.0	%
$I_{LED1..3\ RIPPLE}$	LED1...LED3 ripple current	BW=10MHz	I_{LED} > 5mA			10	% of I_{LED}
			I_{LED} < 5mA			500	µA
$I_{LED1..3\ PWMLIN}$	LED1...LED3 linearity[2]	I_{LED}=20mA, PWM frequency 300Hz	PWM>=25/255	-2		+2	%
			25/255> PWM>=1/255	-10		+10	%
f_{PWM}	PWM input frequency	on pin ON		100	300	800	Hz
$I_{LED1..3\ LEAKAGE}$	LED1...LED3 leakage current	current source off, T_{AMB} < +50ºC		-0.5	0	+0.5	µA
V_{ILED_COMP}	LED1...LED3 current source voltage compliance	Minimum voltage between pin VOUT and LED1...LED3, I_{LED}<20mA[3]		100			mV
Current Reference (pin ISET)							
V_{ISET}	ISET voltage				1.25		V
$I_{LED2ISET}$	LED current to ISETcurrent				400		A/A
Protection Functions **(see page 12)**							
V_{VOUT_MAX}	VOUT overvoltage protection			8.6		10.0	V
$V_{VOUT_OPENLED}$	VOUT open LED detection threshold	Voltage level on VOUT where open LED detection is performed		8.0	8.5	8.8	V
V_{LED_OPEN}	$V_{VLED1..3}$ open detection	an open LED is assumed if the voltage on the current source is less than V_{LED_OPEN} and VOUT=$V_{VOUT_OPENLED}$			92	125	mV
V_{LED_SHORT}	$V_{LED1..3}$ short detection	voltage on LED1..3 where a shorted LED is assumed			0.95		V
$t_{LED_ERROR_DEB_OPEN}$	$V_{LED1..3}$ open debounce time	Open LED detection debounce time				4.8	µs
$t_{LED_ERROR_DEB_SHORT}$	$V_{LED1..3}$ short debounce time	Short LED detection debounce time[4]				9.0	µs
I_{LIMIT}	Current Limit for coil L_{SW} (Pin SW)			510	600	685	mA
T_{OVTEMP}	Overtemperature Protection	Junction temperature			144		ºC
$T_{OVTEMPHYST}$	Overtemperature Hysteresis				5		ºC
V_{UVLO}	Undervoltage Lockout	Falling V_{VIN}		1.8	1.9	2.1	V
		Rising V_{VIN}		V_{UVLO} +0.05	2.2	2.3	V
Digital Interface							
V_{IH}	High Level Input Voltage			1.07		V_{VIN}	V
V_{IL}	Low Level Input Voltage			0.0		0.68	V
$R_{PULLDOWN}$	Pulldown resistor		1.8V on pad	90	250		kΩ

1. Excluding variation of external resistor R_{ISET}; voltage difference between any set of drivers less than 200mV

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2. Note: It is not recommended to operate the current sources at minimum duty cycle with low LED currents.
3. The dcdc output voltage VOUT is regulated to 150mV above the maximum LED voltage (LED1...LED3) to guarantee proper operation of the current with output voltage ripple and undershoots (e.g. due to PWM or supply voltage changes)
4. The short LED detection debounce time is longer than the open LED detection debounce time to allow the parasitic capacitance of the LED to charge above V_{LED_SHORT} within this time and avoid wrong triggering of short LED detection.

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7 Typical Operating Characteristics

V_{BAT} = 3.7V, T_A = +25ºC (unless otherwise specified).

Figure 3. DCDC Efficiency vs. VBAT

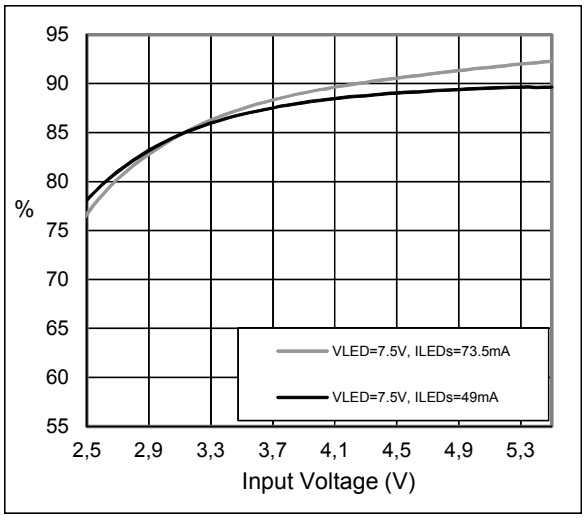


Figure 4. LED Efficiency vs. VBAT

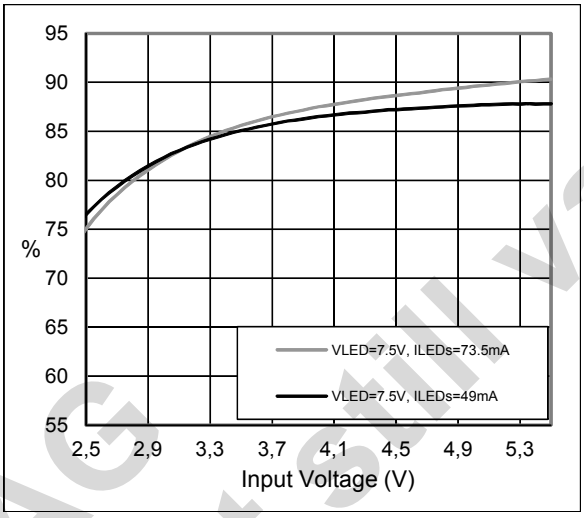


Figure 5. Efficiency vs. Load Current

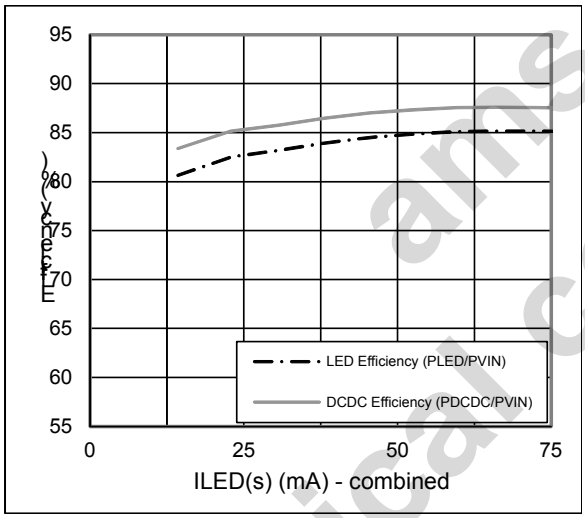


Figure 6. Startup with PWM, 20% duty cycle

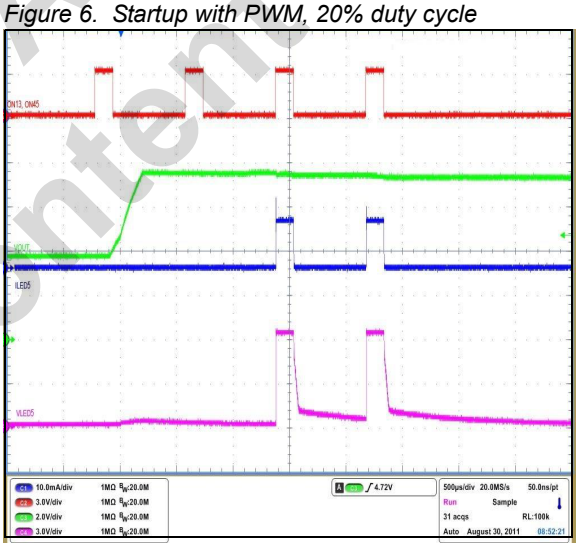


Figure 7. Startup with PWM, 70% duty cycle

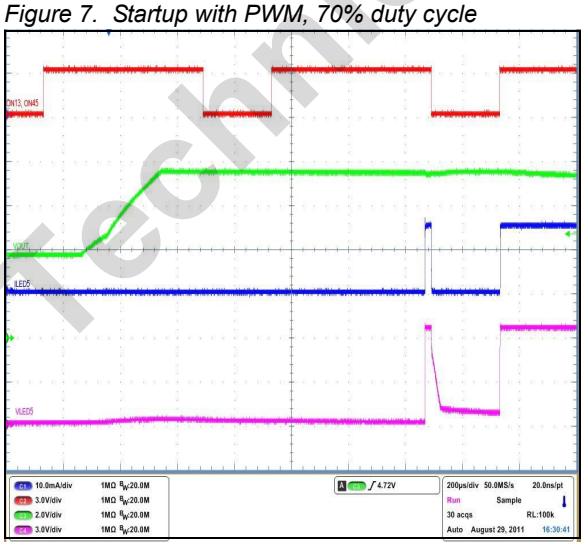
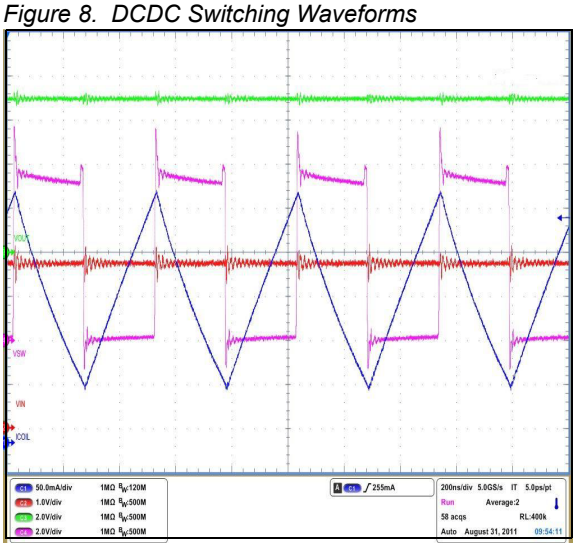


Figure 8. DCDC Switching Waveforms



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Figure 9. Open LED Detection Waveform

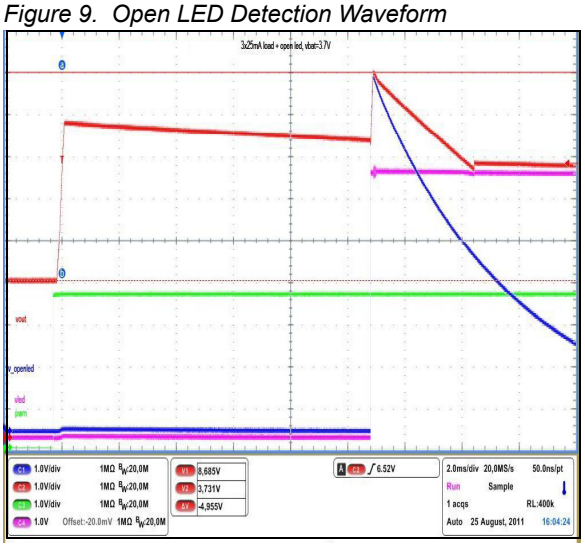


Figure 10. VIN line transient 10µs (ILOAD=100mA)

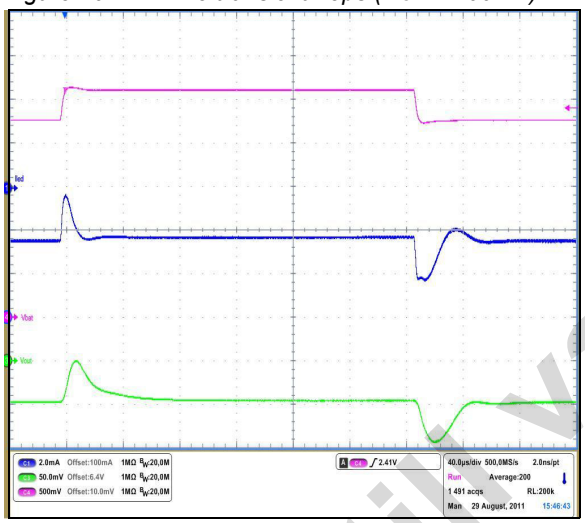


Figure 11. VOUT ripple with PWM

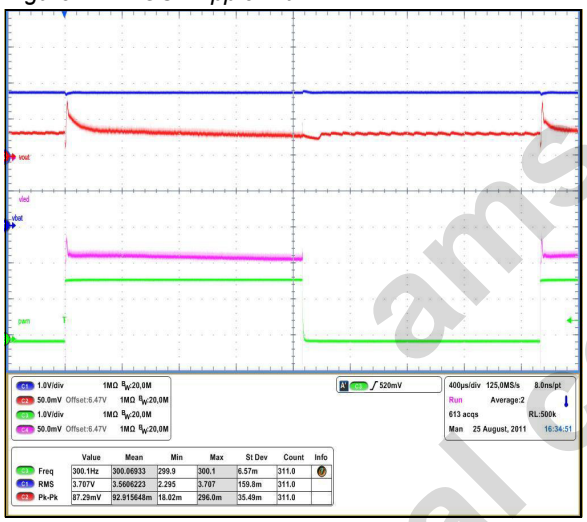


Figure 12. ILED ripple (ILOAD=100mA)

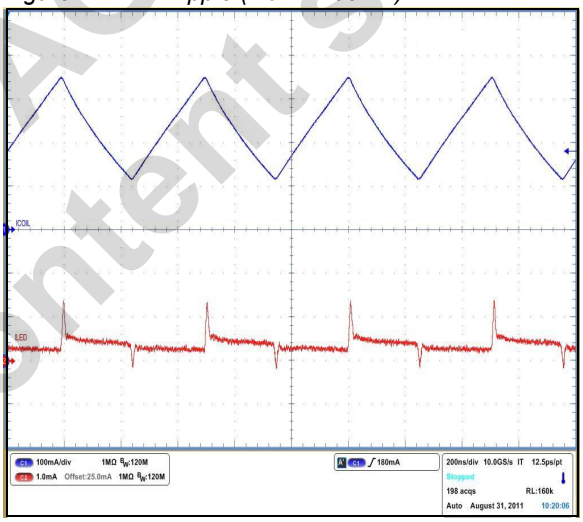


Figure 13. ILED vs. RISET

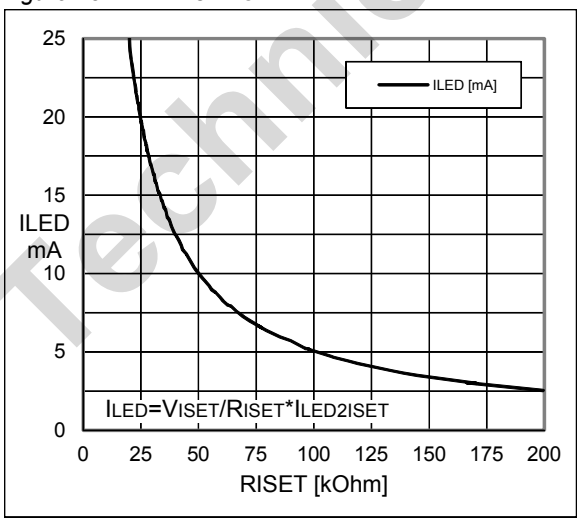
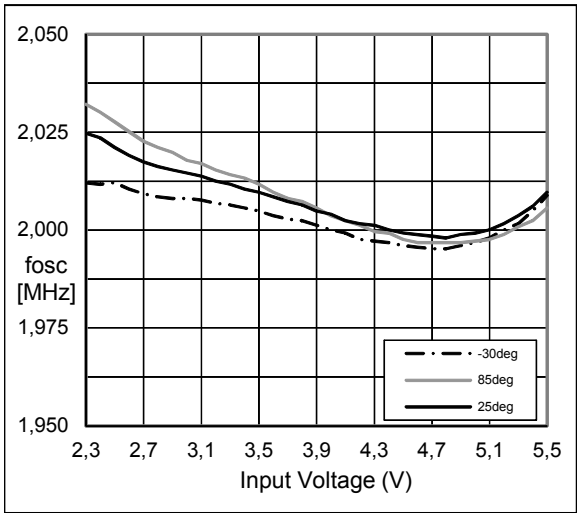
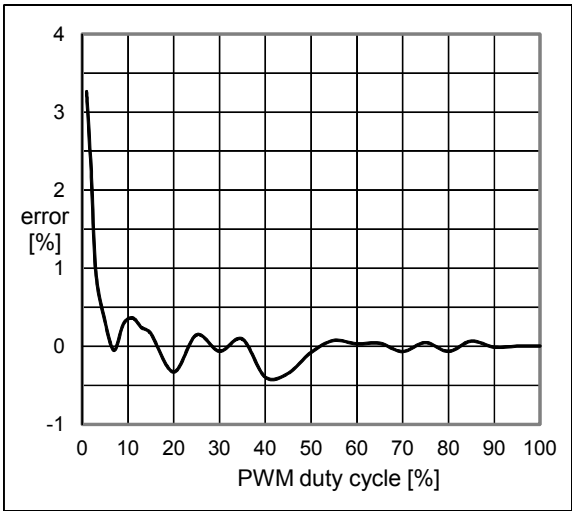


Figure 14. fosc vs.VIN



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Figure 15. Current Error vs. duty cycle (I_{LED}=25mA)



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8 Detailed Description

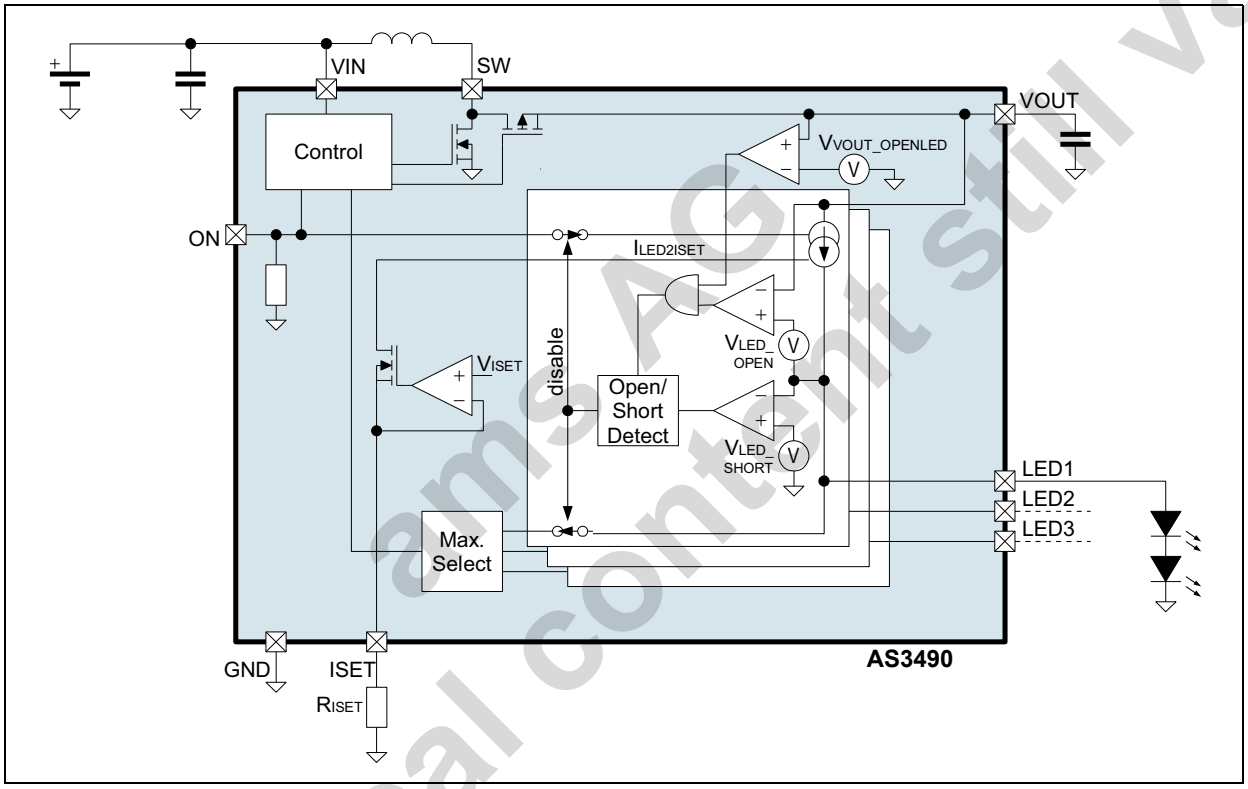
The AS3490 is a high performance DCDC step up converter and three current sources in a small WL-CSP12 package.

The LED configuration is done in up to three strings[1], each strings using two LEDs in series[2]. This configuration results in excellent application efficiency even using very small external components (capacitors and coil). The device is controlled by ON. A high levels on this input enables the DCDC and the current sources. ON can be used as PWM input[3] to accurately control the LED brightness.

The target application is to use the AS3490 for highly efficient backlight driver (display and/or keypad backlight).

Internal Circuit

Figure 16. AS3490 internal circuit



The AS3490 includes a fixed frequency DCDC step-up with accurate startup control. It is enabled by the input pin ON and controls the LED current with five current sources. These input can be used as PWM inputs to control the brightness:

- a high level on ON enables LED1, LED2 and LED3

The current is adjustable by an external resistor RISET.

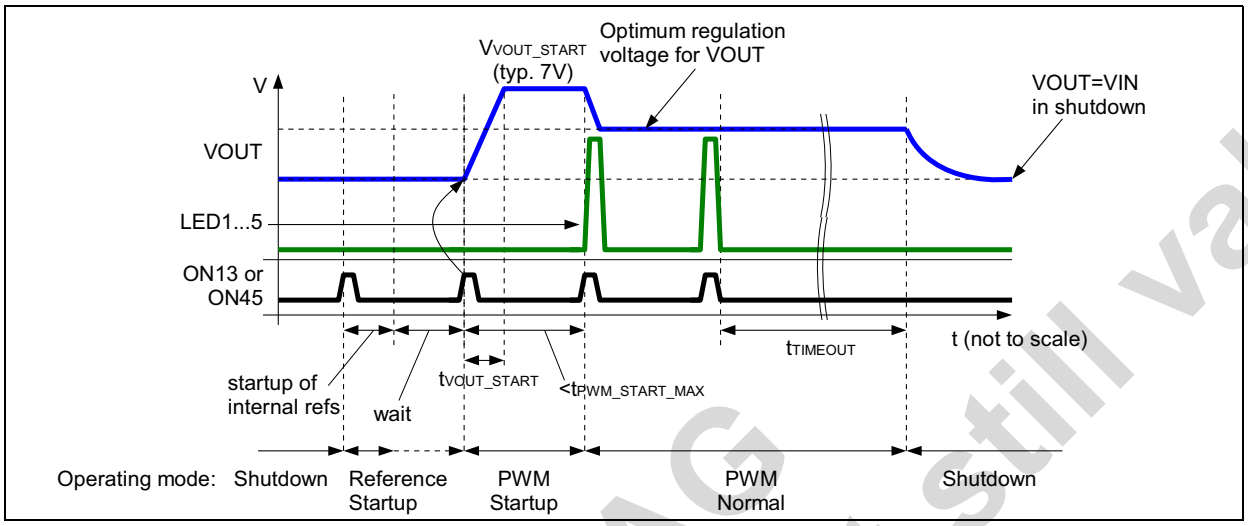
1. Unused strings shall be connected to VOUT or GND.
2. Single LED strings can be mixed with dual LED strings as long as one string has two LEDs in series - it will reduce application efficiency.
3. Using the PWM inputs, the AS3490 supports DLS, dynamic luminance scaling, also called CABC, content adaptive backlight control or DBC, dynamic backlight control.

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Startup

In order to avoid inrush-current during startup the supplies are smoothly ramped up according to Figure 17 even under low PWM duty cycle conditions. This allows the easy integration into mobile battery powered systems:

Figure 17. Startup Procedure



Open and short LED detection

After the startup is finished, the AS3490 continuously monitors open and shorted LEDs. If an open or shorted LED string is detected, this LED string is disabled and the driver continuous its normal operation. The driver is disabled to keep the efficiency of AS3490 for different LED configurations high. The error is cleared once the AS3490 enters shut-down[4].

Shorted LED

After startup is finished, for any LED, enabled by the inputs ON, is below V_{LED_SHORT}, for at least $t_{LED_ERROR_DEB_SHORT}$, a shorted LED is assumed.

Open LED

LED outputs (LED1...LED5) which are not used by the application shall be connected permanently to VOUT or GND. The AS3490 detect this condition upon startup and automatically disables the current sources for these LEDs - see Figure 18 and Figure 19, immediately after the rising edged of ON.

For LEDs, which are open during operation of the device, following procedure of the AS3490 is used for detection:

After startup is finished, if the voltage on VOUT=$V_{VOUT_OPENLED}$[5] and the voltage across any current source, enabled by the inputs ON, is below V_{LED_OPEN} (VOUT-LED1...3), for at least $t_{LED_ERROR_DEB_OPEN}$, an open LED is assumed.

Figure 18 shows the waveform for the detection of a single open LED, Figure 19 for all LEDs open.

4. The error is automatically cleared as the open/short LED error might be temporarily (e.g. bouncing of the connections to the LED)
5. If the current limit of the coil (I_{LIMIT}) is reached before VOUT=$V_{VOUT_OPENLED}$, an open LED is not detected.

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Figure 18. Single Open LED detection

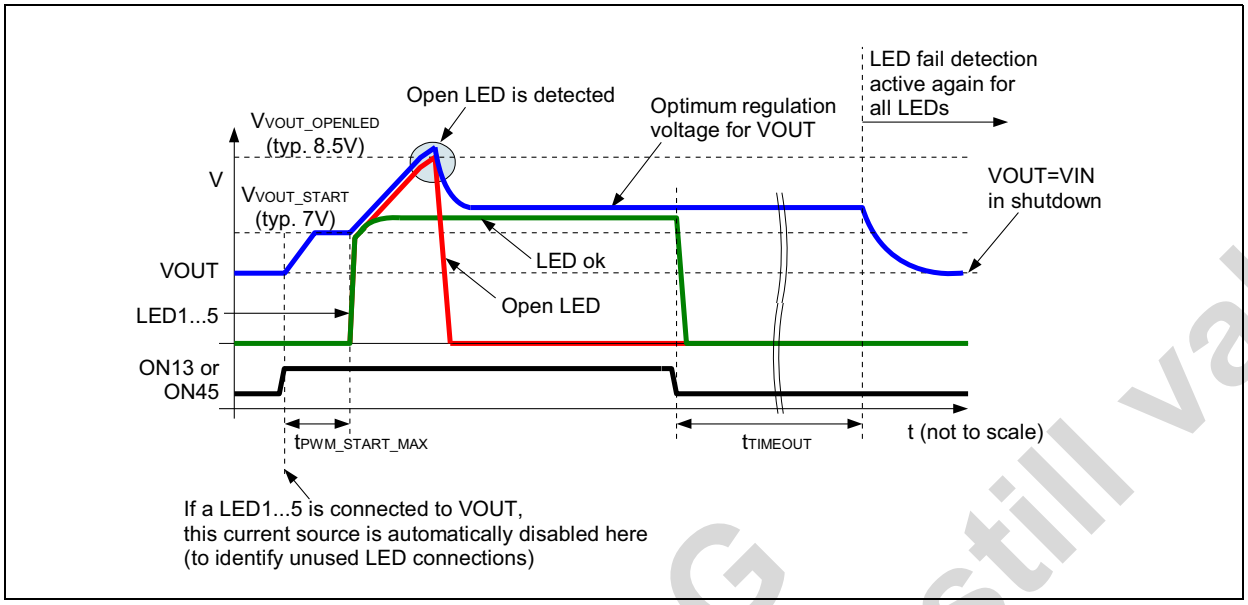
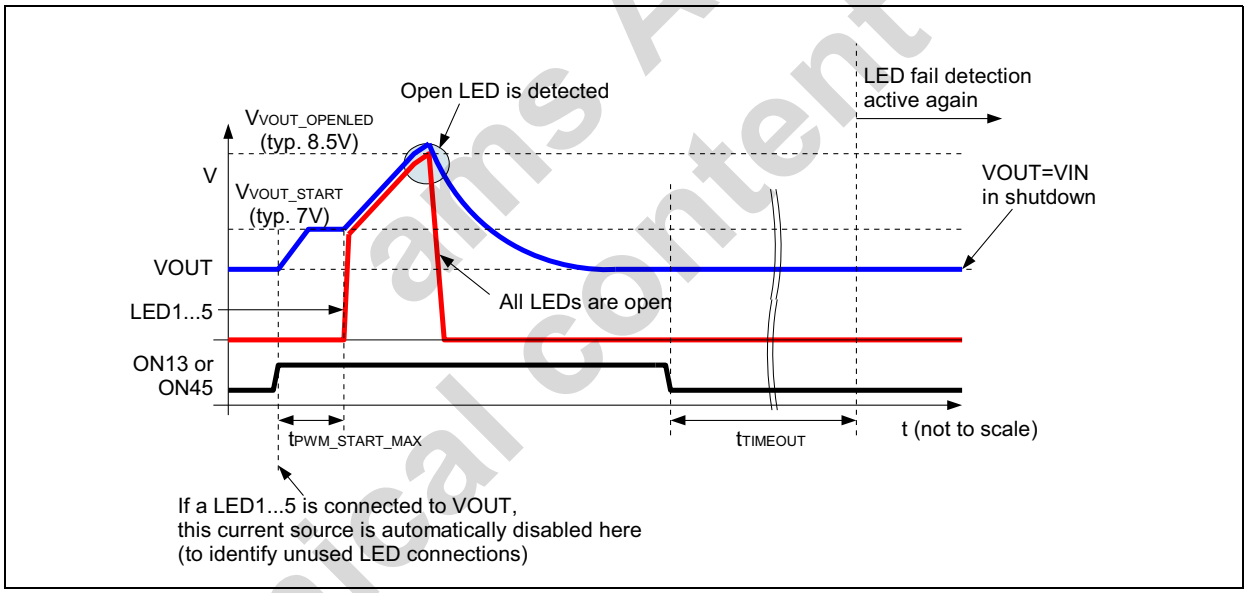


Figure 19. All LEDs open



Protection and Fault Detection Functions

The protection functions protect the AS3490, its external components and connected LEDs against physical damage.

Overvoltage Protection

The voltage on VOUT is kept below or at V_{VOUT_MAX} under every operating condition[6]. If the voltage on VOUT is at V_{VOUT_MAX} for more than 70ms[7], the DCDC will shutdown. It can be re-enabled by setting ON to low for more than $t_{TIMEOUT}$.

6. When reaching VOUT=$V_{VOUT_OPENLED}$, the open LED detection is performed.
7. The duration can vary from 55ms to 85ms within a single AS3490.

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DCDC Inductor Peak Current Limitation

To limit the maximum current from the battery, the DCDC converter limits its current through the coil to ILIMIT on a cycle by cycle basis.

Overtemperature Protection

The junction temperature of the AS3490 is continuously monitored. If the temperature exceeds TOVTEMP, the DCDC is stopped. The driver is automatically re-enabled once the junction temperature drops below TOVTEMP-TOVTEMPHYST.

Supply undervoltage Protection

If the voltage on the pin VIN is or falls below VUVLO, the AS3490 is kept in shutdown.

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9 Application Information

External Components

Input Capacitor C_{VIN}

Low ESR input capacitors reduce input switching noise and reduce the peak current drawn from the battery. Ceramic capacitors are required for input decoupling and should be located as close to the device as is practical.

Table 4. Recommended Input Capacitor

Part Number	C	TC Code	ESR	Rated Voltage	Size	Manufacturer
GRM155R60J225ME15	2.2µF +/-20%	X5R		6V3	0402 (1.0x0.5x 0.5mm)	Murata www.murata.com
GRM155R60J155M---D	1.5µF	X5R		6V3		
ECJ0MBFJ185V		X5R			0402 (1.0x0.5x 0.5mm)	Panasonic Matsushita www.panasonic.com
JDK105BJ155MVNF		X5R			0402 (1.0x0.5x 0.5mm)	Taiyo Yuden www.taiyo-yuden.com

If a different input capacitor is chosen, ensure similar ESR value and at least 0.6µF capacitance at the maximum input supply voltage. Larger capacitor values (C) may be used without limitations.

Output Capacitors C_{OUT}

Low ESR capacitors should be used to minimize VOUT ripple. Multi-layer ceramic capacitors are recommended since they have low ESR and are available in small footprints. The capacitor should be located as close to the device as is practical.

X5R dielectric material is recommended due to their ability to maintain capacitance over wide voltage and temperature range.

Table 5. Recommended Output Capacitor C_{OUT}

Part Number	C	TC Code	ESR	Rated Voltage	Size	Manufacturer
GRM219R61A116UE82L	10µF	X5R	120mΩ	10V	0805 (2x1.25x 0.85mm)	Murata www.murata.com
LDK212BJ106MDNT	10µF	X5R		10V	0805 (2x1.25x 0.85mm)	Taiyo Yuden www.taiyo-yuden.com

If a different output capacitor is chosen, ensure similar ESR values and at least 4.2µF @ 5.6V and maximum 20µF capacitance.

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Inductor LSW

The fast switching frequency (2MHz) of the AS3490 allows for the use of small SMDs for the external inductor. The inductor should have low DC resistance (DCR) to reduce the I^2R power losses - high DCR values will reduce efficiency.

Table 6. Recommended Inductor

Part Number	L	DCR	Size	Manufacturer
LQM2HPN4R7MGC	4.7µH; >2.45µH @ 0.5A	160mΩ	2.5x2.0x0.9mm max height 1.0mm	Murata www.murata.com
CIG32K1R0SAF	4.57µH; >2.45µH @ 0.5A	<300mΩ	2.0x1.25x0.9mm max height 1.0mm	Samsung Electro-Mechancs www.sem.samsung.co.kr

If a different inductor is chosen, ensure similar DCR values and at least 2.45µH inductance at maximum peak input current.

PCB Layout Guideline

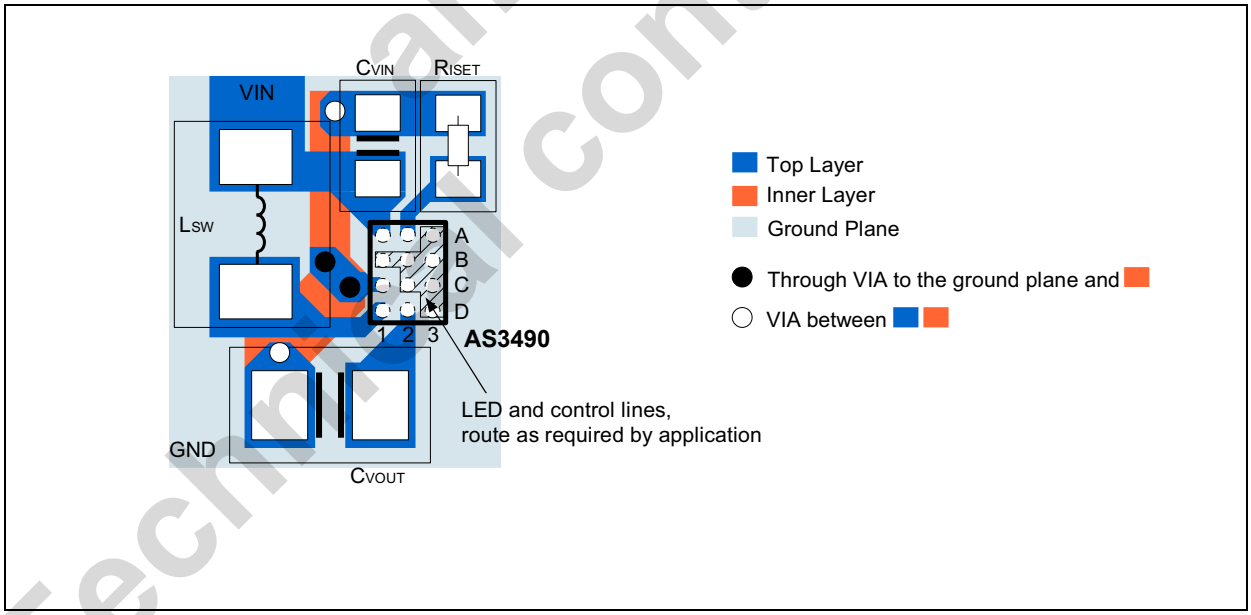
The high speed operation requires proper layout for optimum performance. Route the power traces first and try to minimize the area and wire length of the three high frequency/high current loops:

Loop1: pin GND - CVIN - LSW - pin SW - pin GND

Loop2: pin GND - CVIN - LSW - pin SW - pin VOUT - CVOUT - pin GND

At the pin GND a single via (or more vias, which are closely combined) connects to the common ground plane. This via(s) will isolate the DCDC high frequency currents from the common ground (as most high frequency current will flow between Loop1 and Loop2 and will not pass the ground plane) - see the 'island' at the two through ground vias in Figure 20:

Figure 20. Layout recommendation

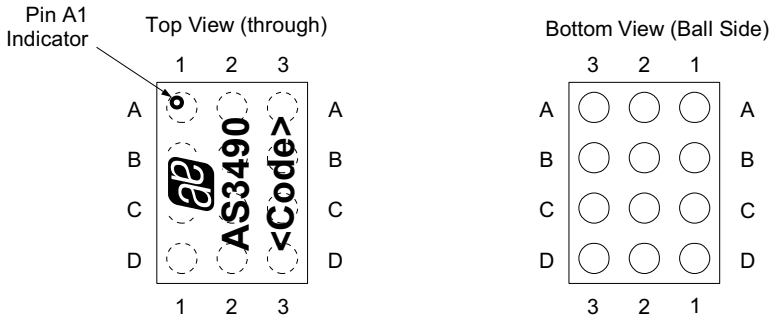


Note: If component placement rules allow, move all components close to the AS3490 to reduce the area and length of Loop1 and Loop2

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10 Package Drawings and Markings

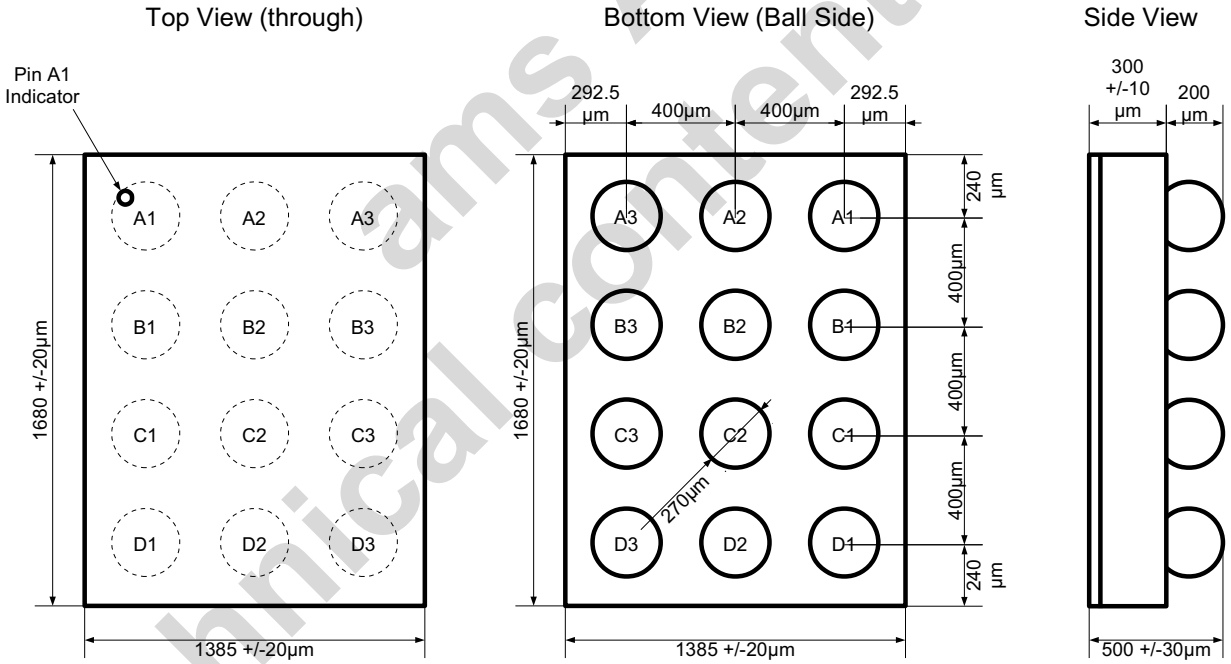
Figure 21. 12pin WL-CSP12 1.7x1.4x0.5mm Marking



Note:

Line 1: austriamicrosystems logo
Line 2: AS3490
Line 3: <Code>
Encoded Datecode (4 characters)

Figure 22. 12pin WL-CSP12 1.7x1.4x0.5mm Package Dimensions



The coplanarity of the balls is 40µm.

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11 Ordering Information

The devices are available as the standard products shown in Table 7.

Table 7. Ordering Information

Model	Description	Delivery Form	Package
AS3490-ZWLT	Highly Efficient 2-6 LEDs Backlight Driver with PWM Input	Tape & Reel	12-pin WL-CSP (1.7x1.4x0.5mm) RoHS compliant / Pb-Free / Green

Note: All products are RoHS compliant and austriamicrosystems green.
Buy our products or get free samples online at ICdirect: http://www.austriamicrosystems.com/ICdirect

Technical support is found at http://www.austriamicrosystems.com/Technical-Support

For further information and requests, please contact us mailto:sales@austriamicrosystems.com or find your local distributor at http://www.austriamicrosystems.com/distributor

Note: AS3490-ZWLT

AS3490-
- Z Temperature Range: -30ºC - 85ºC
- WL Wafer Level Chip Scale Package (WL-CSP) 1.7x1.4x0.5mm
- T Delivery Form: Tape & Reel

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